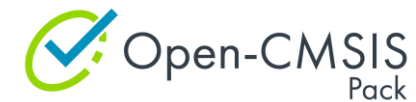


Open-CMSIS-Pack

Technical Project Meeting 2023-11-07

This meeting is recorded !



Agenda

- Welcome
- Project Boards
- Issues for Review
- Attract 3rd party software vendors
- Wrap Up

Boards:

- [Open-CMSIS-Pack Specification Change Board](#)
- [CMSIS-Toolbox 2.2 Project Board](#)
 - See progress and issues in scope for version 2.2.0
 - Please review and provide feedback in case you see topics missing
 - Add issues or comment on existing issues that you think should be added to 2.2.0
- [CMSIS-Toolbox 2.3 Project Board](#)

Issues to Review

- [csolution] `list generators` command display directories and `contexts` info [#1171](#)
- [csolution] Explicit section of Automatic Linker Script Generator [#1175](#)
- Implement <csolution-name>.cbuild-pack.yml [#1122](#) (ST) (PR [#1143](#))
 - Document cbuild-pack.yml PR [#76](#) - in progress
- A `pack:` specified with `path:` in YAML input takes precedence over regularly installed pack version [#1098](#)
- [csolution] Should we change extension to `*.yaml` of generated files? [#1186](#)
- [csolution] Ensure that *.csolution.yml projects are usable [#1177](#)
- [csolution] output for component selection is misleading [#1187](#)

Issues to Review (cont'd)

- [csolution] Using packs via local_repository.pidx [#1172](#)
- [RTE] provide access to component version from the application [#1154](#)
- [csolution] add support for toolchain agnostic `pre-include` files in YAML [#808](#)

Defects:

- [csolution] access sequence ` \$Dname\$ ` undefined if only a board is specified [#1184](#)
- [csolution] \$Dname\$/\$Bname\$ differ from RTE converted file and path names ('-' replaced by '_') [#1185](#)

What is required to get 3rd party software in packs

- Better Guidance for 3rd party vendors; <https://github.com/Open-CMSIS-Pack/SW-Pack-HandsOn> is insufficient as 3rd party vendors do not understand the workflow
 - ✓ Scripts for pack creation and tutorials are there
- Understanding how a software components are used to create an application
- To achieve flexibility for 3rd party vendors, alignment on API interfaces that can be used
- Cclass Taxonomy Management to ensure compatibility
- Pack datasheet generator that shows how the software appears to the user
- Better IDE workflows, potentially leveraging pack datasheets (i.e. via a web service)

Cclass Taxonomy Management

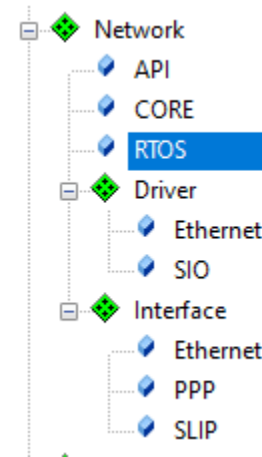
- github.com/Open-CMSIS-Pack/Open-CMSIS-Pack-Taxonomy
- New Cclass issue template:
 - https://github.com/Open-CMSIS-Pack/Open-CMSIS-Pack-Taxonomy/issues/new?assignees=&labels=new+Cclass&projects=&template=cclass_request.yml
- Example: Cclass CMSIS
 - <https://github.com/Open-CMSIS-Pack/Open-CMSIS-Pack-Taxonomy/issues/1>

Create applications from components

- [New Section in Documentation](#)
- Could we get feedback on what is missing? [#1189](#)
- Can we work on tutorials and examples?
 - What should be used, i.e. based on LwIP, FreeRTOS, AWS components?
- Can we get help on pack datasheets? [#262](#)
- How should complex examples be published?
 - Via links to github? Similar to <https://github.com/Arm-Examples>
 - Could we change the approach to examples by leveraging clayers for boards?

Pack Datasheet [#260](https://github.com/Open-CMSIS-Pack/IwIP): github.com/Open-CMSIS-Pack/IwIP

- Generated “Pack Datasheet” based on *.PDSC XML data
- Possible “datasheet” content based on PDSC file
 - Pack
 - Link to documentation
 - License
 - Keywords (for search)
 - Components
 - External dependencies (required components)
 - Exposed header files (API)
 - Configuration files, user code template files, examples
 - Release history
- Not directly possible (based on PDSC file) but potential useful
 - Mandatory components (that a user must select)
 - Provided interfaces (i.e. BSD socket)
 - Maybe exposed header files is sufficient?
 - [Overview diagram](#) (could be part of documentation)
 - Related components (i.e. Crypto, IoT socket, Cloud stacks, RTOS kernels)
 - Maybe by listing packs that require components from this pack



<input type="checkbox"/>	lwIP	2.2.0	lwIP (Lightweight IP stack)
<input type="checkbox"/>		2.2.0	Network high-level wrapper API
<input type="checkbox"/>	IPv4/IPv6	2.2.0	Network Core (IPv4/IPv6)
<input type="checkbox"/>	CMSIS-RTOS2	2.2.0	OS abstraction layer (CMSIS-RTOS2)
<input type="checkbox"/>	CMSIS Driver	2.2.0	Ethernet Interface using CMSIS Ethernet Driver
<input type="checkbox"/>	CMSIS Driver	2.2.0	Serial I/O Interface using CMSIS USART Driver
			Connection Mechanism
<input type="checkbox"/>		2.2.0	Network Ethernet Interface
<input type="checkbox"/>		2.2.0	Network PPP over Serial Interface
<input type="checkbox"/>		2.2.0	Network SLIP Interface

Pack cross reference

Used by:

- pack: MDK-Packs::IoT_Socket

IwIP::lwIP

uses:

- component: CMSIS:RTOS2
- component: RTOS&FreeRTOS:Core
- component: CMSIS Driver:Ethernet
- component: CMSIS Driver:Ethernet MAC
- component: CMSIS Driver:Ethernet PHY
- component: CMSIS Driver:USART

Pack Datasheet example *needs more work*: <https://github.com/ReinhardKeil/IwIP/tree/patch-1>

Wrap Up

Is anyone preparing/working on a topic to present and discuss in the coming weeks?

- Please contact Joachim.Krech@arm.com ahead of the meeting

Next Open-CMSIS-Pack meeting: 14th Nov 2023 @ 16:00 CET (15:00 UK)

Thank you

